Mini TOPLED®





Applications

- Cluster, Button Backlighting
- Electronic Equipment

- Interior Illumination (e.g. Ambient Map)
- Transportation, Plane, Ship

Features:

- Package: SMD epoxy package
- Chip technology: Thinfilm
- Typ. Radiation: 120° (Lambertian emitter)
- − Color: $λ_{dom}$ = 633 nm (• super red)
- Corrosion Robustness Class: 3B
- Qualifications: The product qualification test plan is based on the guidelines of AEC-Q101-REV-C,
 Stress Test Qualification for Automotive Grade Discrete Semiconductors.
- ESD: 2 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)



Ordering Information			
Туре	Luminous Intensity 1) I _F = 20 mA I _V	Ordering Code	
LS M67F-T2V1-1-G3R3	355 900 mcd	Q65112A6735	



Maximum Ratings			
Parameter	Symbol		Values
Operating Temperature	T _{op}	min. max.	-40 °C 100 °C
Storage Temperature	T_{stg}	min. max.	-40 °C 100 °C
Junction Temperature	T _j	max.	125 °C
Forward current T _S = 25 °C	I _F	max.	30 mA
Surge Current t \leq 10 μ s; D = 0.005 ; T _s = 25 °C	I _{FS}	max.	100 mA
Reverse voltage ²⁾ T _S = 25 °C	V_R	max.	12 V
ESD withstand voltage acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 2)	V_{ESD}		2 kV



Characteristics

 $I_F = 20$ mA; $T_S = 25$ °C

Parameter	Symbol		Values
Peak Wavelength	λ_{peak}	typ.	645 nm
Dominant Wavelength ³⁾ I _E = 20 mA	λ_{dom}	min. typ.	627 nm 633 nm
1 _F = 20 H/A		max.	639 nm
Spectral Bandwidth at 50% I _{rel,max}	Δλ	typ.	16 nm
Viewing angle at 50% $\rm I_{\rm v}$	2φ	typ.	120 °
Forward Voltage ⁴⁾ I _F = 20 mA	V _F	min. typ. max.	1.90 V 2.05 V 2.50 V
Reverse current ²⁾ V _R = 12 V	I _R	typ. max.	0.01 μA 10 μA
Temperature Coefficient of Peak Wavelength -10°C ≤ T ≤ 100°C	$TC_{\lambda peak}$	typ.	0.15 nm / K
Temperature Coefficient of Dominant Wavelength -10°C ≤ T ≤ 100°C	$TC_{\lambda dom}$	typ.	0.05 nm / K
Temperature Coefficient of Forward Voltage -10°C ≤ T ≤ 100°C	TC_{VF}	typ.	-2.5 mV / K
Real thermal resistance junction/ambient 5)6)	R _{thJA real}	max.	580 K / W
Real thermal resistance junction/solderpoint 5)	$R_{thJS\ real}$	max.	330 K / W



Brightness Groups

Group	Luminous Intensity ¹⁾ I _F = 20 mA min. I _v	Luminous Intensity. 1) I _F = 20 mA max. I _v	Luminous Flux $^{7)}$ $I_F = 20 \text{ mA}$ $typ.$ Φ_V
T2	355 mcd	450 mcd	1210 mlm
U1	450 mcd	560 mcd	1520 mlm
U2	560 mcd	710 mcd	1910 mlm
V1	710 mcd	900 mcd	2420 mlm

Forward Voltage Groups

Group	Forward Voltage ⁴⁾ I _F = 20 mA min. V _F	Forward Voltage ⁴⁾ I _F = 20 mA max. V _F	
G3	1.90 V	2.05 V	
K3	2.05 V	2.20 V	
N3	2.20 V	2.35 V	
R3	2.35 V	2.50 V	



Group Name on Label

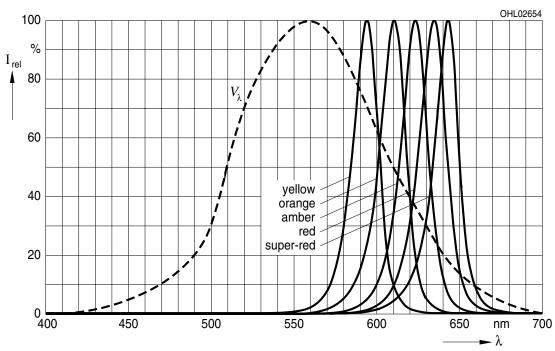
Example: T2-1-G3

Brightness	Wavelength	Forward Voltage
T2	1	G3



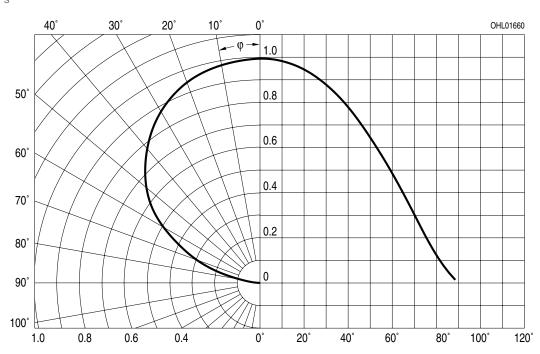
Relative Spectral Emission 7)

$$I_{rel} = f(\lambda); I_F = 20 \text{ mA}; T_S = 25 ^{\circ}\text{C}$$



Radiation Characteristics 7)

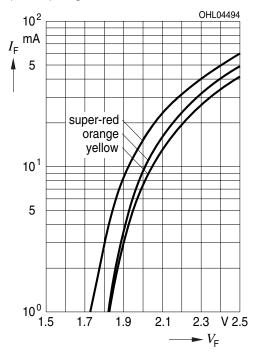
$$I_{rel} = f(\phi); T_S = 25 °C$$





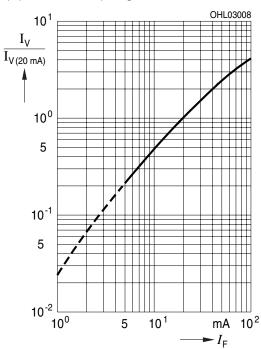
Forward current 7), 8)

$$I_F = f(V_F); T_S = 25 \, ^{\circ}C$$



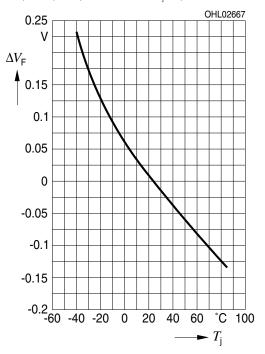
Relative Luminous Intensity 7), 8)

$$I_{v}/I_{v}(20 \text{ mA}) = f(I_{F}); T_{S} = 25 \text{ °C}$$



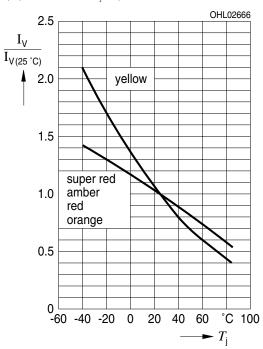
Forward Voltage 7)

$$\Delta V_{_F} = V_{_F} - V_{_F} (25~^{\circ}\text{C}) = f(T_{_j});~ I_{_F} = 20~\text{mA}$$



Relative Luminous Intensity 7)

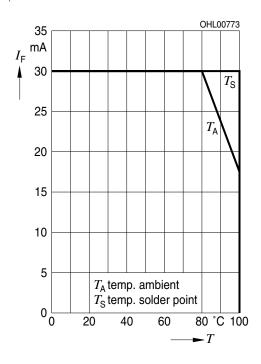
$$I_{v}/I_{v}(25 \text{ °C}) = f(T_{j}); I_{F} = 20 \text{ mA}$$





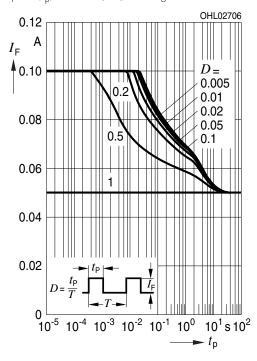
Max. Permissible Forward Current

 $I_F = f(T)$



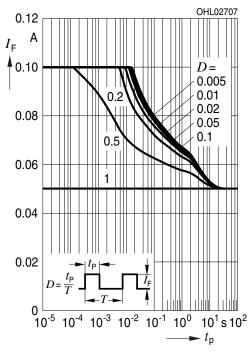
Permissible Pulse Handling Capability

 $I_F = f(t_D)$; D: Duty cycle; $T_S = 25 \, ^{\circ}\text{C}$

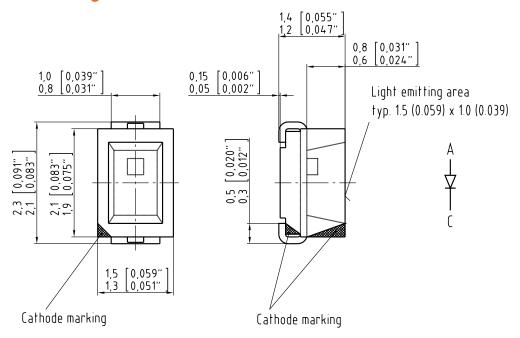


Permissible Pulse Handling Capability

 $I_{_{\rm F}}$ = f(t $_{_{
m D}}$); D: Duty cycle; $T_{_{
m S}}$ = 85 °C



Dimensional Drawing 9)



C63062-A3740-A1.. -05

Further Information:

Approximate Weight: 7.0 mg

Package marking: Cathode

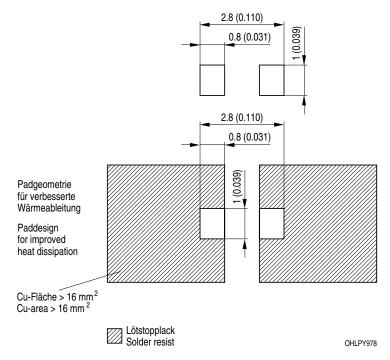
Corrosion test: Class: 3B

Test condition: 40°C / 90 % RH / 15 ppm H₂S / 14 days (stricter than IEC

60068-2-43)



Recommended Solder Pad 9)

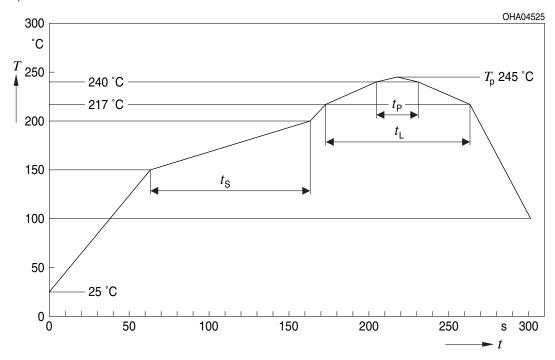


For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere. Package not suitable for ultra sonic cleaning.



Reflow Soldering Profile

Product complies to MSL Level 2 acc. to JEDEC J-STD-020E



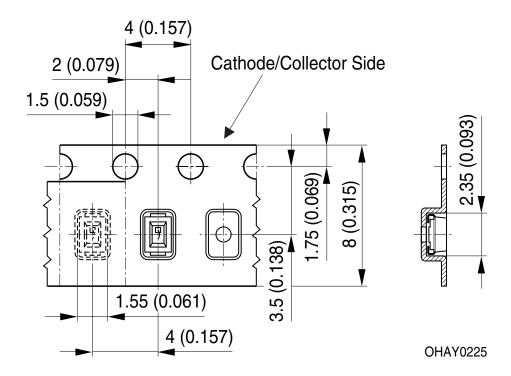
Profile Feature	Symbol	Pb	Pb-Free (SnAgCu) Assembly		
		Minimum	Recommendation	Maximum	
Ramp-up rate to preheat*)	'		2	3	K/s
25 °C to 150 °C					
Time t _s	t _s	60	100	120	S
T_{Smin} to T_{Smax}	-				
Ramp-up rate to peak*)			2	3	K/s
T_{Smax} to T_{P}					
Liquidus temperature	T_L		217		°C
Time above liquidus temperature	$t_{\scriptscriptstyle L}$		80	100	S
Peak temperature	T_{P}		245	260	°C
Time within 5 °C of the specified peak temperature T _P - 5 K	t _P	10	20	30	S
			2		I//a
Ramp-down rate* T_P to 100 °C			3	6	K/s
Time				480	S
25 °C to T _P					

All temperatures refer to the center of the package, measured on the top of the component

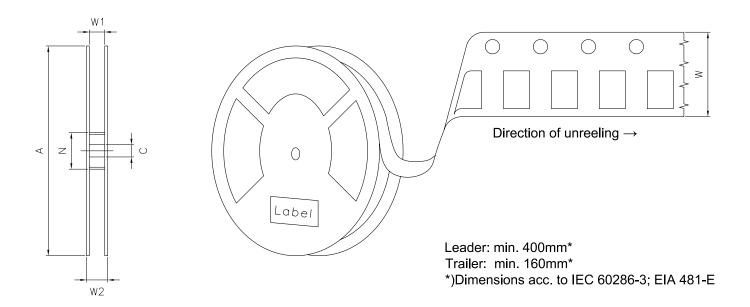


 $^{^{\}ast}$ slope calculation DT/Dt: Dt max. 5 s; fulfillment for the whole T-range

Taping 9)



Tape and Reel 10)



Reel Dimensions

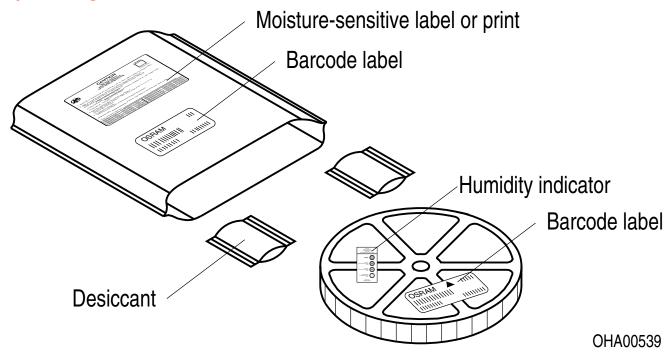
Α	W	N_{\min}	W ₁	$W_{2 max}$	Pieces per PU
180 mm	8 + 0.3 / - 0.1 mm	60 mm	8.4 + 2 mm	14.4 mm	3000



Barcode-Product-Label (BPL)



Dry Packing Process and Materials 9)



Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.



Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet fall into the class **exempt group (exposure time 10000 s)**. Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

For further application related information please visit www.osram-os.com/appnotes



Disclaimer

Attention please!

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version on the OSRAM OS website.

Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

Product and functional safety devices/applications or medical devices/applications

OSRAM OS components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.

OSRAM OS products are not qualified at module and system level for such application.

In case buyer – or customer supplied by buyer – considers using OSRAM OS components in product safety devices/applications or medical devices/applications, buyer and/or customer has to inform the local sales partner of OSRAM OS immediately and OSRAM OS and buyer and /or customer will analyze and coordinate the customer-specific request between OSRAM OS and buyer and/or customer.



Glossary

- Brightness: Brightness values are measured during a current pulse of typically 25 ms, with an internal reproducibility of ± 8 % and an expanded uncertainty of ± 11 % (acc. to GUM with a coverage factor of k = 3).
- Reverse Operation: This product is intended to be operated applying a forward current within the specified range. Applying any continuous reverse bias or forward bias below the voltage range of light emission shall be avoided because it may cause migration which can change the electro-optical characteristics or damage the LED.
- Wavelength: The wavelength is measured at a current pulse of typically 25 ms, with an internal reproducibility of ±0.5 nm and an expanded uncertainty of ±1 nm (acc. to GUM with a coverage factor of k = 3).
- Forward Voltage: The forward voltage is measured during a current pulse of typically 8 ms, with an internal reproducibility of ± 0.05 V and an expanded uncertainty of ± 0.1 V (acc. to GUM with a coverage factor of k = 3).
- Thermal Resistance: Rth max is based on statistic values (6σ) .
- ⁶⁾ **Thermal Resistance:** RthJA results from mounting on PC board FR 4 (pad size 16 mm² per pad)
- Typical Values: Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- ⁸⁾ Characteristic curve: In the range where the line of the graph is broken, you must expect higher differences between single devices within one packing unit.
- Tolerance of Measure: Unless otherwise noted in drawing, tolerances are specified with ±0.1 and dimensions are specified in mm.
- ¹⁰⁾ **Tape and Reel:** All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.



Revision	n History	
Version	Date	Change
1.6	2021-04-14	Description



Leibnizstraße 4, D-93055 Regensburg www.osram-os.com © All Rights Reserved.

Published by OSRAM Opto Semiconductors GmbH EU RoHS and China RoHS compliant product

此产品符合欧盟 RoHS 指令的要求;

按照中国的相关法规和标准,不含有毒有害物质或元素。



X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Standard LEDs - SMD category:

Click to view products by Osram manufacturer:

Other Similar products are found below:

LTST-C19GD2WT LTST-N683GBEW LTW-170ZDC LTW-M140SZS40 598-8110-100F 598-8170-100F 598-8610-202F 67
22VRVGC/TR8 AAAF5060QBFSEEZGS ALMD-LB36-SV002 APT1608QGW 15-21UYC/S530-A3/TR8 EASV1803BA0 LG M67K-H1J2
24-0-2-R18-Z LS A676-P2S1-1 SML-512VWT86A SML-LX0606SISUGC/A SML-LXL1307SRC-TR SML-LXR851SIUPGUBC

LT1ED53A FAT801-S AM27ZGC03 APB3025SGNC APFA3010SURKCGKQBDC APHK1608VGCA APT2012QGW CLX6D-FKB
CN1R1H1BB7D3D3 LTST-008BGEW LTST-C250KGKT LTW-010DCG LTW-020ZDCG LTW-21TS5 LTW-220DS5

JANTXM19500/521-02 UYGT801-S 42-21UYC/S530-A3/TR8 LO T67F-V1AB-24-1 YGFR411-H SML-LX0402IC-TR

CMDA20AYAA7D1S CMDA16AYDR7A1X 339-1SURSYGW/S530-A2 598-8040-100F 598-8070-100F 598-8140-100F 598-8610-200F

EAST2012GA0 SML-LXL1209SYC/ATR EASV3020YGA0 EAST1608RGBA0